

TECHNOLOGY DEVELOPMENT BOARD

M/s Terminus Circuits Pvt. Ltd., Bangalore signed a Loan Agreement with Technology Development Board on 16th March, 2017 for a loan assistance for 'Commercialization of High Speed serial link products'.

The agreement would help Terminus Circuits in expanding the availability of its silicon proven IPs in variety of flavors to improve its customer base in India and worldwide; these products which are import substitutes and export oriented. Terminus circuits is 7+ year old company in the design and development of High Speed Serial Link products. Its flagship products are USB3.0/3.1, PCIE Gen4/3/2/1 and multi-standard SerDes. The innovative architectures developed in-house bring in the superior performance products with high throughput and low latency. The state-of-the-art subsystems like PCIE Gen4, USB3.1 and the HSS links that go into high end computing systems like High Performance Computers for cloud computing, brain simulations, weather forecasting in enterprise applications and for applications like laptops, mobiles etc., in consumer products. Terminus Circuits provides the physical layer solutions that are corner stone products in the development of hyper converged systems with integrated storage, networking and computing.



Exchanging the Loan Agreement with M/s Terminus Circuits Pvt. Ltd., Bangalore